


**PRODUCT / PROCESS CHANGE INFORMATION**

**1. PCI basic data**

<b>1.1 Company</b>		STMicroelectronics International N.V
<b>1.2 PCI No.</b>	ADG/21/13022	
<b>1.3 Title of PCI</b>	SOT223 - SOT323 - PowerFLAT 3x3 : Additional Carrier and Cover Tape Supplier	
<b>1.4 Product Category</b>	see list	
<b>1.5 Issue date</b>	2021-09-23	

**2. PCI Team**

<b>2.1 Contact supplier</b>	
<b>2.1.1 Name</b>	NEMETH KRISZTINA
<b>2.1.2 Phone</b>	+49 89460062210
<b>2.1.3 Email</b>	krisztina.nemeth@st.com
<b>2.2 Change responsibility</b>	
<b>2.2.1 Product Manager</b>	Mario ASTUTI,Angelo RAO,Stephane CHAMARD,Maurizio GIUDICE
<b>2.1.2 Marketing Manager</b>	Anna RANIOLO,Michele SCUTO,Philippe LEGER,Natale Sandro D'ANGELO,Paolo PETRALI
<b>2.1.3 Quality Manager</b>	Vincenzo MILITANO,Jean-Paul REBRASSE

**3. Change**

<b>3.1 Category</b>	<b>3.2 Type of change</b>	<b>3.3 Manufacturing Location</b>
Materials	New Indirect material part number (same supplier or different supplier): Boxes, trays, carriers, back grinding tape, wafer mounting tape, mold tape, etc..	Subcontractor TFME (China)

**4. Description of change**

	<b>Old</b>	<b>New</b>
<b>4.1 Description</b>	Carrier: KOSTAT Cover Tape: DENKA	Carrier: KOSTAT and Wuxi Furun Cover Tape: DENKA and SUMITOMO
<b>4.2 Anticipated Impact on form,fit, function, quality, reliability or processability?</b>	No impact	

**5. Reason / motivation for change**

<b>5.1 Motivation</b>	Double Source Suppliers for Service improvement
<b>5.2 Customer Benefit</b>	SERVICE IMPROVEMENT

**6. Marking of parts / traceability of change**

<b>6.1 Description</b>	Date code
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**7. Timing / schedule**

<b>7.1 Date of qualification results</b>	2021-09-15
<b>7.2 Intended start of delivery</b>	2021-10-31
<b>7.3 Qualification sample available?</b>	Upon Request

**8. Qualification / Validation**

<b>8.1 Description</b>	13022 Qualification TFME Additional supplier for carrier and cover tape.pptx		
<b>8.2 Qualification report and qualification results</b>	Available (see attachment)	<b>Issue Date</b>	2021-09-23

**9. Attachments (additional documentations)**

13022 Public product.pdf  
13022 PCI Add supplier TFME carrier and cover tape.pdf  
13022 Qualification TFME Additional supplier for carrier and cover tape.pptx

**10. Affected parts**

10. 1 Current		10.2 New (if applicable)
10.1.1 Customer Part No	10.1.2 Supplier Part No	10.1.2 Supplier Part No
	Z0109MN 5AA4	

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